MHFT Readout Electronics Status and Plans

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Warm Readout Schematics

LiteBIRD TES sensors are read by means of FDM = Frequency Domain Multiplexing. Each TES, acting as a variable resistance sensitive to varying incoming microwave radiation, modulates a current that is read by a SQUID.

When each TES is put in series to a superconducting LC filter, a sum of sinusoids can be used to read with a single SQUID a large number (>60) of detectors in parallel.



LiteBIRD Warm Readout is defined as the hardware required to bias and read the SQUIDs, multiplex the signals used to operate and record the output of the bolometer detectors, process the resulting signals from the SQUIDs, and provide the resulting science data to its destination.

Three telescopes \rightarrow same readout



Warm Readout Schematics

It is composed of two logic blocks: the SQUID Controller Units (SCU) and the Signal Processing Units (SPU)

SCU – the (mostly analog) frontend readout – is provided by INFN with ASI (Italy)

SPU – the digital section (FPGA + digitizers) – is provided by McGill with CSA (Canada)



Design of the WRE = SPU + SCU

2021: Digital hardware, updated DA, thermal/mech (SPU) and radiation-tolerant firmware reached TRL-5



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SCU branched to a separate development being handled by INFN.

SCU is placed outside the service module, close to the focal planes and sitting besides the cryocoolers

We give more details on the SCU development \rightarrow take all WRE at the same level of maturity



This is why we have an independent documentation for SCU



Technical Feasibility of

SQUID Controller Units

for Phase-A2 Review

	Name	Date & visa
Prepared by	Giovanni Signorelli Michele Pinchera Andrea Tartari Maurizio Massa Andrea Moggi Mario Zannoni Giulia Conenna	15 March 2023
Approved by		

Version	date	Modifications	Name
1.0	15/03/2023	Version for Phase A2 KP Review Panel	G. Signorelli

References

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SCU Design Definition and Justification

The SQUID Controller Units (SCU) are in charge of performing the front-end readout of the TESs of the three telescopes: LFT, MFT ad HFT.

They provide bias (carrier) and nuller signals to the bolometers on 4 SQUID modules; they bias and retrieve signals from the SQUIDs.

They are designed to

- Send the bias signals (1 to 5 MHz carriers) to the TESs on the focal plane;
- Provide a single SQUID bias in the range $0-400 \ \mu\text{A}$;
- Readout and amplify (x60) the signals from a single SQUID (expected signal in the range 1–9 mV);
- Provide a heater current for trapped flux removal (through a +5V generator);
- Send the nulling signal to the SQUID input coil;
- Send an extra flux bias to the SQUID through the input coil;
- Implement "performance" redundancy on the warm readout side (1xSCA \rightarrow 2xSPA) w/mechanical relays

At the time of the writing of this presentation a discussion is ongoing on adopting a different philosophy, "functional redundancy", in which it is acceptable to have a degradation in the performance of the instrument, that can be compensated otherwise.

The main difference with the presented design is that with the "functional redundancy" philosophy each SCA is connected one-to-one with a single SPA, eliminating the need of the relays.

This modification simplifies the design and the presented schedules and AIV are compatible with the alternative redundancy scheme



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SCE - Mechanical & Thermal design

- Mechanical enclosure (SCE) holds 8 SCA boards
- Placed in a "hostile" environment
 - Prototype-0 of SQUID controller enclosure designed
 - Built a preliminary 3D printed version
 - Built a EDMachined version complete of electroplating
 - EMI shields for the boards
 - Under JAXA-INFN NDA
 - Routing of cables, positioning of the units -
 - Refine form factor, interfaces
 - Improve thermal contact, simplify tests



Design



3D printed prototype



EDM prototype

New design





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SCE - Mechanical & Thermal design

• The resent design is a consequence of several simulations and subject to future tests



- The present prototypes are being used in INFN-PI cryogenic test facilities for SCA performance tests
- Thermal analysis under developement, to be carried on at a dedicated facility in INFN-LNF
- Includes thermal study of SCA

Power dissipation on SCA









SCA design according to requirements

All the functions have been implemented in a breadboard which is fully form-fit since, despite being populated with COTS components, already contains the footprint of flight components.



The present design is under revision by an industrial partner (Thales Alenia Space Italy, TASI) for

- confirmation / check of our design solutions
- verification of space rules/flight components
- cost evaluation and planning for the procurement of the boards (SCA)

The SCU will then be assembled, tested and qualified under INFN/ASI responsibility

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Three SCUs will be delivered: SCU-L, SCU-M and SCU-H. The three units will be identical, except the fact that SCU-L will host only 6 operating boards, though having 8 slots.

SCE has been designed to host 8 boards and the same enclosure will be used for all three SCUs to simplify the total cost including verification and qualification of the units. In case of SCU-L suitable dummy boards will occupy the 2 extra slots in the enclosure.







The electrical functional properties of the electronics board have been fully verified in a three stages:

- bench-top at INFN-MIB @ room temperature
- dedicated EMI-shielded test chamber at INFN-PI, at room temperature, using resistive/reactive networks as dummy loads.





We have completed a test campaign at McGill facilities to assess the performance of the SCA prototype model when used in a realistic setting, to control SQUID Array Amplifiers embedded in a FDM TES readout chain \rightarrow TRL 4/5

Performed in July 2022 at McGill (Canada) by McGill and INFN personnel, some more tests ongoing in these days to verify some minor points



Dil Fridge inside EMI chamber

SQUIDs and dummy TESs

WRE coupling test results

In this test campaign, we have demonstrated that:

- 1. the interfaces between the SCA and McGill D/A Assembly work as expected in all the aspects: connector compatibility, communication (data and command I/O), low noise analog signal transfer/amplification to/from the SQUID.
- 2. the noise added by SCA is lower or equal to the one added by equivalent electronics based on COTS components (and without switching stage) developed by the McGill group for ground-based experiments.



 \rightarrow The readiness level of the SCU is TRL4/5. For thermal and shielding functionalities, standard solutions will be adopted on the path towards TRL6, which is delineated in the following slides.



Figure 10. Noise at the SQUID input comparisons. Left: board SCA#3 vs SPT-3G board (COTS). Right: board SCA#3 vs the same board with a 100Ω resistor in order to disable a current sharing path at high frequency.

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Model philosophy and verification

Proto-flight model/flight model (PFM/FM) approach will be used as model philosophy.

- One Engineering Model of SCU for performance validation at unit level
- Three Proto-Flight/Flight Models and Flight Spare of SCU

LiteBIRD SCU HW Matrix	BBM			EM PFM/		M/FM		Flight	Total qty			
	GSE LFT	GSE MFT	GSE HFT	STM***	EM1**	EM2**	LFT	MFT	HFT	Spare	COTS ver	Flight Quality
SQUID Controller Assembly (SCA)	6 (+2dummies)	8	8	1 (+ 7dummies)	4	4	6 (+2dummies)	8	8	8*	29 (+11dummies)	30
SCU Enclosure (SCE)	1	1	1	1		1	1	1	1	1	5	4

* flight spare SCAs as baseline are 8 (4 deliverables as a minimum). The Flight Spare SCAs will be qualified at SCU level.

** EM1 is a set of 4 SCAs deliverable to CSA/JAXA for the integrated WRE/Instrument EM env test campaign

** EM2 is a separate not deliverable EM set of 4 SCAs

The 2 SCA EM sets will be tested at unit level using 1 EM SCE

*** STM is a not deliverable model

A set of BBM (three BBM SCUs and a STM SCU) will be used for the early verification/validation at sub-unit level (SCA).

Will provide sufficient information (proof of concept/model correlation) to enable the progression of the project to the next, more representative models.

The BBM will be manufactured with commercial components and the tests performed on this model will not be part of qualification, acceptance or validation tests. The tests will be used to verify the technology readiness at level 6.



The test matrix for the assumed model philosophy.

LiteBIRD SCU T	est Matrix	BBM	EM	PFM (2)	FM (3)	FS (4)
Functional & Perform	nance					
	Functional	Т	Т	Т	Т	Т
	Performance	Tsca	Т	Т	Т	Т
Physical Properties						
	Mass	Т	Т	Т	Т	Т
	CoG	Α	Α	Α	A	Α
	Mol	Α	Α	А	Α	Α
Structural Test						
	Vibration	T (1)	Т	Tp	Ta	Та/Тр
	Shock		T(5)	Tp(5)	Ta(5)	Ta/Tp(5)
	Acoustic			At Satellite le	evel only	
Thermal Test	TV/TB	T (1)	Т	Тр	Ta	Та/Тр
EMC/EMI			Т	Тр	Ta	Та/Тр
ESD			T(5)			

(1) Test with a STM consisting of SCE BBM + 1 SCA BBM + SCA dummies

(2) The Protoflight specified tests are performed for the first PFM unit of the SCU (PFM#1)

(3) Acceptance level tests will be performed on subsequent 3 FMs

(4) The Flight Spare will be 1 of the 4 SCU PFMs/FMs, so it will be qualified at acceptance level as a minimum

(5) Test is TBC

Development Plan

The SCU preliminary master schedule until phase D is reported in the back-up slides.

We show here the key milestones and the main goals that have to be respected to ensure the milestone achievement.

The SCU key milestones dates have to be agreed on the basis of a consolidated schedule from JAXA/prime team.

In this preliminary master schedule are considered the WRE delivery need dates provided by JAXA in Dec 2022.

Event or Milestone	Date
SCU Phase B KO	02/01/2024
SCU BBM TRB/DRB & handover to CSA	16/07/2024
SCU BBM LF/HF/MF DELIV to CSA	06/08/2024
WRE BBM LF/HF/MF DELIV to JAXA (Jan 2025)	02/01/2025
SCU PDR	03/01/2025
SCU Phase C/D KO	06/01/2025
SCU EM TRB/DRB & handover to CSA	13/05/2025
SCU EM LF/HF/MF DELIV to CSA	03/06/2025
WRE EM LF/HF/MF DELIV to JAXA (Oct 2025)	14/10/2025
SCU CDR	15/10/2025
SCU FM TRB/DRB & handover to CSA	11/02/2027
SCU FM LF/HF/MF DELIV to CSA	04/03/2027
WRE FM LF/HF/MF DELIV to JAXA (Sep 2027)	09/09/2027

JAXA updates (March 31 2023, Dotani): Japanese system companies (NEC and Melco) cannot accept an order from JAXA in FY2024 due to the conflict with their manufacturing plan/capability \rightarrow delay of the launch by a year or two (from January 2031). The start of phase B will also be delayed. JAXA will keep the schedule of SRR as much as possible \rightarrow timing to fix the interfaces will not change.

Detailed schedule

ID	Task Name	Duration	Start	Finish	2023 Half 2, 2023 Half 1, 2024 Half 2, 2024 Half 1, 2025 Half 2, 2025 Half 1, 2026 Half 2, 2026 Half 1, 2027 Half 2, 2027
1	LiteBIRD SCU Main Schedule	1119 days	12/05/23	09/09/27	
2	SCU Events and Delivery Milestones	972 days	04/12/23	09/09/27	
3	WRE BBM LF/HF/MF DELIV to JAXA (Jan 2025)	0 days	02/01/25	02/01/25	2/01/2025
4	WRE EM LF/HF/MF DELIV to JAXA (Oct 2025)	0 days	14/10/25	14/10/25	● 14/10/2025
5	WRE FM LF/HF/MF DELIV to JAXA (Sep 2027)	0 days	09/09/27	09/09/27	
6	MHFT-SCU Phase A2 Review (Dec 2023)	0 days	04/12/23	04/12/23	• 04/12/2023
7	SCU Phase B KO	0 days	02/01/24	02/01/24	♠ 02/01/2024
8	SCU Phase C/D KO	0 days	06/01/25	06/01/25	06/01/2025
9	SCU Phase Bridging (Phase A2 Completion)	164 days	12/05/23	29/12/23	
10	SCU LF/HF/MF BBM design, analyses	5 mons	12/05/23	28/09/23	
11	SCU LF/HF/MF BBM Manufacturing	64 days	29/09/23	29/12/23	
12	SCA GSE design & MAIT	4 mons	07/09/23	29/12/23	
13	LiteBIRD SCU Phase B	261 days	02/01/24	03/01/25	
14	SCU BBM AIT & TRL6	140 days	02/01/24	15/07/24	
15	SCU LF/HF/MF BBM AIT	5 mons	02/01/24	20/05/24	
16	SCU/SCA STM Vib + TV Tests (TRL6)	2 mons	21/05/24	15/07/24	TRL6
17	SCU BBM LF/HF/MF Units Delivery & WRE Integrated AIT	119 days	16/07/24	02/01/25	
18	SCU BBM TRB/DRB & handover to CSA	0 days	16/07/24	16/07/24	a 16/07/2024
19	SCU BBM LF/HF/MF DELIV to CSA	0 days	06/08/24	06/08/24	\$ 06/08/2024
20	WRE Integrated BBM AIT support	4.6 mons	07/08/24	12/12/24	
21	WRE BBM LF/HF/MF DELIV to JAXA	0 days	02/01/25	02/01/25	\$ 02/01/2025
22	SCU GSE design & MAIT	4 mons	21/05/24	10/09/24	
23	SCU EM design, analyses	2 mons	17/07/24	10/09/24	
24	SCU EM MAIT	4 mons	11/09/24	03/01/25	
25	SCU PDR	0 days	03/01/25	03/01/25	03/01/2025
26	LiteBIRD SCU Phase C	202 days	07/01/25	15/10/25	
27	SCU EM Qualification Env Tests	4.5 mons	07/01/25	12/05/25	
28	SCU EM LF/HF/MF Units Delivery & WRE Integrated AIT	110 days	13/05/25	14/10/25	
29	SCU EM TRB/DRB & handover to CSA	0 days	13/05/25	13/05/25	13/05/2025
30	SCU EM LF/HF/MF DELIV to CSA	0 days	03/06/25	03/06/25	\$ 03/06/2025
31	WRE Integrated EM AIT support	4 mons	04/06/25	23/09/25	
32	WRE EM LF/HF/MF DELIV to JAXA	0 days	14/10/25	14/10/25	14/10/2025
33	SCU FM design and analyses	3 mons	23/07/25	14/10/25	
34	SCU CDR	0 days	15/10/25	15/10/25	\$ 15/10/2025
35	LiteBIRD SCU Phase D	491 days	16/10/25	09/09/27	
36	SCU FM design and analyses refinement	2 mons	16/10/25	10/12/25	
37	SCU FM MAIT	9 mons	11/12/25	24/08/26	
38	SCU FM Protoflight/Acceptance tests	6 mons	25/08/26	10/02/27	
39	SCU FM LF/HF/MF Units and FS Unit Delivery & WRE Integrated AIT	150 days	11/02/27	09/09/27	
40	SCU FM TRB/DRB & handover to CSA	0 days	11/02/27	11/02/27	11/02/2027
41	SCU FM LF/HF/MF DELIV to CSA	0 days	04/03/27	04/03/27	04/03/2027
42	WRE Integrated FM AIT support	6 mons	05/03/27	19/08/27	
43	WRE FM LF/HF/MF DELIV. to JAXA	0 days	09/09/27	09/09/27	\$ 09/09/2027

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The SCU AIV/AIT campaign is to demonstrate that:

- the SQUID Controller design at unit level is qualified at the environmental condition;
- the SCU is free from material and workmanship defects;
- the overall SQUID Controller (including procedures and resources) is able to fulfil the mission requirements, providing all the performances requirement during the mission period;
- the SCU verified in conjunction with the other WRE units and LiteBIRD Instruments work properly;
- the Final Model is delivered in due time;

As an example the AIV flow for the BBM shows the matching with CSA AIV flow



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The AIV flow for EM and FM takes in consideration the procurement of the SCAs from industrial partners, while all subsequent activities will be carried out within INFN responsibility.

All the SCU PA/QA matters will be managed by INFN experienced PA personnel following ECSS-Q-ST standards.

The SCU PA/QA manager will act as focal point of the INFN SCU Team for all the PA matters and establish/maintain liaison with the LiteBIRD Italian collaboration (ASI), CNES, CSA and JAXA.



EM AIV

FM AIV



- Discussion on the redundancy policy
 - Functional redundancy instead of performance redundancy
 - Performance = guarantee that we are left with at least 90% of the detectors
 - Functional = allow to lose part of the detectors if we can compensate otherwise (e.g. increasing the observation time)
- Reduces the number of cold/hot spares in the SPUs
- Has implications on the design of the SCA since we need to remove the circuitery that allows the HOT/COLD switch
 - the design, somehow, simplifies
- A decision will be taken after the JAXA MDR (after summer)
- We are anticipating the design modifications to be compliant with the schedule.





- Identified some hardware modifications on the SCA boards
 - To match the modularity of the focal planes and independency of "pixels"







- Increase the number of pixels in HFT
 - Verify that it has no impact on the present readout design

Resource	Design Name	HF1 195/280 GHz	HF2 235/337 GHz	HF3 402 GHz	% Change from PTEP HE1/2/3
Pixel Count	PTEP	127	127	169	
Pixel Count	PPD1	147	147	192	+16/16/14%
	PPD2	162	162	264	+28/28/56%
	PPD3	162	162	330	+28/28/95%
Muy Faster	PTEP	62	62	62	
Mux Factor	PPD1	68	68	66	+10/10/6%
	PPD2	68	68	68	+10/10/10%
	PPD3	68	68	68	+10/10/10%
	PTEP	8	8	6	
SQUID Count	PPD1	9	9	6	+13/13/0%
	PPD2	10	10	8	+25/25/33%
	PPD3	10	10	10	+25/25/60%

PTEP





PPD1



Ø224.0



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- The SQUID Controller Units will be delivered under our responsibility
 - Excellent collaboration with McGill colleagues. Need to interact at "institutional" level
- The design (electrical-mechanical) is well advanced and subject to some decisions from the collaboration
 - Definition of the redundancy policy
 - Modularity of the connections with the focal planes
 - Exact placement on the payload
- TRL advancement is in sync with the schedule
- AIV plan has been envisaged and being sync'd with Canada
 - Test facilities being put in place for cryogenic tests / thermal-vacuum tests
 - Other test activities (cosmic rays, particle flux, etc.)
- We are ready for the end-of-year CNES review
 - Will manufacture three units by the end of the year. Ready to proceed towards phase-B!





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SCU workshop LNF 24.5.2023

09:00	Intro Speaker: Giovanni Signorelli (Istituto Nazionale di Fisica Nucleare)	© 15m
09:15	LiteBIRD Readout Chain Speaker: Eugenia Di Giorgi (INFN Pisa)	③20m
09:35	SCU Electronics (design, versions, timeline) Speaker: Andrea Passerini (MIB)	(§ 20m
09:55	TASI Study status Speaker: Mario Zannoni (Istituto Nazionale di Fisica Nucleare)	(§ 15m
10:10	Analysis of McGill Data Speaker: Giulia Conenna	©25m
10:35	SCU mechanics (design, simulations, models) Speaker: Maurizio Massa (INFN Pisa)	© 20m
11:30	SCU Tests and qualifications Speaker: Andrea Tartari (Istituto Nazionale di Fisica Nucleare)	③ 20m
11:50	Schedule, model philosophy, AIV Speaker: Michele Pinchera (Istituto Nazionale di Fisica Nucleare)	(§ 25m
12:15	LNF Thermovacuum facility Speaker: Luca Porcelli (Istituto Nazionale di Fisica Nucleare)	𝔇 25m
14:30	Cosmic ray effects and detector test on beamline Speakers: Andrea Tartari (Istituto Nazionale di Fisica Nucleare), Stefano Della Torre (Istituto Nazionale di Fisica Nucleare)	© 20m
14:50	Irradiation of LTC1668 at LNL Speaker: Giovanni Signorelli (Istituto Nazionale di Fisica Nucleare)	©15m
15:05	Discussion session	©20m

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End of slides

Status of Doc for Phase-A2 Review

The overall status of the WRE documentation is very good. Minor syncronizations may be needed following ongoing tests/design optimizations.

Sub-systems	Design Definition and Justification TRL achievement	Technical Budget (mass, thermal, electrical, data)	AIV Plan Only AIV flow for each model as given in 2021_11_18_MHFT_models&sch edule.pptx	Development Plan (Models & Schedule)	Breadboard Test results	Requirements Specification
WRE (SPU)	ок	ok (SPU)	minor sync	minor sync	ок	minor sync
WRE (SCU)	ОК	ОК	minor sync	minor sync	Minor refinements	minor sync

Delivered documentation for the KP:

/Warm Readout Electronics									
	LBRD-DD-001-LiteBIRD-Warm-Readout-Design-Description v1.0	Mc Gill WRE Design	Final						
	LBRD-RPT-002-Warm-Electronics-Development-Plan	Mc Gill WRE Dev Plan	Final						
	LBRD-IRD-001-LiteBIRD-Warm-Readout-IRD v2.4	Mc Gill WRE IRD	Final						
	LBRDSTDP RPT10 Honeywell Vibration and Thermal Cycling Tests	Mc Gill SPU TRL5 Verification:	Final						
	(2021)	Vibration and Thermal cycling tests							
	LBRDSTDP RPT06 McGill TRL5 Verification Summary (2021)	Mc Gill SPU TRL5 Verification Summary	Final						
	TF of SQUID Control Unit_V1_for_CNES_KP	Technical Feasibility for SQUID Control Unit	KP version						
	RPR-LB20005_WRE_IRD_rev2.0_INFN-commented	WRE JAXA IRD	KP version						
	List_of_JAXA-INFN-comments_to_RPR-LB20005_WRE_IRD_rev2.0_2 0230128	Comments to WRE JAXA IRD	KP version						

Canadian Space Agency development of WRE/SPU

TRL-5 status is the product of long development effort

20 20	08	NSERC CRD / CSA / COMDEV EBEX: through small payloads program	T	
20 20	10 11	SPTpol Deployment (Not CSA-funded)		
20 20 20	12 13 14	STDP4 PT-2 First space-qualified readout development		
20 20 20	15 16 17	SPT-3G Deployment POLARBEAR-2 Deployment (Not CSA-funded)		Contra Sandar Angelander Contra Contr
20	18	LiteBIRD Mission Contribution S	itudy	
20	19 20	LiteBIRD Science Maturatio	ect	
20	21	→ STDP16 PT-3	The second se	
20	22	Signal processing dev TRL-5 demonstration	model	
20	23		And the second second	
20	25			
20	26 🔔	Envision (Envision	ned)	
20	27 🔔		Fight Program	
20	28 🔔	Phases A	-D to launch	
20	29 🔔			
	\checkmark			
			COR	



Mechanical and electrical budgets were evaluated by analysis and design and validated after the construction of a prototype enclosure + SCA breadboard, which is form-fit to the flight model.

Mass, form factor, volume and electrical power dissipation of our prototype model are within this subsystem allocated envelope.



Mass, CBE



Figure 11 - Major Z mode (Mode 37), 4582,88 Hz

Mass,

Main

Mass,

200mm×250mm×200mm.



nponent	Component	Qty		CBE	mass, CBE	Contingency	MEV	Component	MEV		
			[kg]	[kg]	[kg]		[kg]	Quantity	[kg]		
	SCU Mechanics (Chassis, Frontal panel, Back Panel)	1	2	2						Compone	
SCU-L	Boards	6+2	0.21	1.68	5	20%	6	1	6		
	Card-locks	16	0.025	0.4						SCU-L	
	Emi Shield and EMI clamps	8	0.115	0.92						SCU-M SCU-H	
	SCU Mechanics (Chassis, Frontal panel, Back Panel)	1	2	2							
CU-M	Boards	8	0.21	1.68	5	20%	6	1	6		
	Card-locks	16	0.025	0.4							
	Emi Shield and EMI clamps	8	0.115	0.92						Compon	
	SCU Mechanics (Chassis, Frontal panel, Back Panel)	1	2	2							
SCU-H	Boards	8	0.21	1.68	5	20%	6	1	6	SCU-L	
	Card-locks	16	0.025	0.4]					SCU-M	
	Emi Shield and EMI clamps	8	0.115	0.92						500-п	
			Table 1 M	lass budget							

Main

component

Partial

Mass.

Total Dissipated power, MEV # of Dissipated Total power to Contingency boards [W] power per dissipate, CBE board, CBE [W] [W] 9.9 1.65 (TBC) 20% 11.9 (TBC) 6 8 1.65 (TBC) 13.2 20% 15.9 (TBC) 1.65 (TBC) 13.2 20% 15.9 (TBC) 8 Total 43.6 (TBC)

Table 2 Thermal power budget

Component	# of boards	Electrical power per board, CBE [W]	Total power , CBE [W]	Contingency	Total Electrical power, MEV [W]
SCU-L	6	1.65	9.9	20%	11.9
SCU-M	8	1.65	13.2	20%	15.9
SCU-H	8	1.65	13.2	20%	15.9
Tota	1				43.6

Table 3 Power budget

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Main Compo

